# FY95 End of Fiscal Year Letter (01 Oct 1994 - 30 Sep 1995)

#### ONR CONTRACT INFORMATION

Contract Title: High Thermal Conductivity Carbon/Carbon Composites

Performing Organization: Clemson University

Principal Investigator: Dr. Dan D. Edie; (803) 656-3056;

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Contract Number: N00014-92-J-4104 (CU REF:05-5002)

R & T Project Number: C/C 9200---01

ONR Scientific Officer: Steven G. Fishman

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# REPORT DOCUMENTATION PAGE

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High Thermal Conductivity (					
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Clemson, SC 29634-0909					
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13. ABSTRACT (Maximum 200 words)					
The objective of this	project was to develop a	low-cost high thermal	conductivity carbon/carbon		
			powder coating process was		
developed which can p	produce a flexible pre-impre	egnated pitch-based tov	vpreg. A combination of a		
pressure-carbonization	technique and heat treatme	nt of the mesophase pi	itch was utilized to enhance		
			fibers, T300 PAN-based, P55		
			h-based, were incorporated as		
the filler phase in the	composites. The thermal co	onductivity of the graph	nitized T300/AR-120 and the		

14. SUBJECT TERMS

15. NUMBER OF PAGES:
8

16. PRICE CODE

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18. SECURITY CLASSIFICATION OF ABSTRACT
Unclassified

20. LIMITATION OF ABSTRACT
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P55/AR-120 composites was 80.5 and 135.5 W/m-K, respectively. The composites reinforced with the experimental ribbon fibers exhibited 3-D anisotropy, with a thermal conductivity, transverse to the fibers, of 213.5 W/m-K, higher than that parallel to the fibers, 145 W/m-K. These results indicate that fiber shape can affect matrix properties in carbon/carbon composites. Using finite element methods, a model was developed to predict the effect of specific material variables, such as fiber fraction, fiber structure, matrix structure, fiber/matrix interface, and void fraction, on the thermal conductivity of the composite.

#### A. Research Goals

The objective of the project was to develop a low-cost, high thermal conductivity carbon/carbon composite with a mesophase pitch-based matrix. In addition, it was proposed that the project employ a pressure-carbonization technique in order to increase the composite density to approximately 1.5 g/cc, resulting in an increase in both the mechanical and thermal properties of the composites.

## B. Significant Results

A low-cost, continuous powder coating process has been developed which can produce a flexible pre-impregnated pitch-based towpreg. The process was used to produce towpreg from Mitsubishi AR mesophase pitch powder and three different carbon fibers: T300 PAN-based fiber, P55 pitch-based fiber, and an experimental high thermal conductivity pitch-based ribbon fiber. The pitch powder was deposited on individual fibers, rather than on bundles of fibers. As a result, the pitch-based towpreg was very flexible and easy to handle. This flexibility will allow the forming of multidimensional pre-impregnated preforms which can be simply hot pressed into composites.

The thermal conductivity (parallel to the fibers) of the graphitized T300/AR-120 and P55/AR-120 composites was 80.5 and 135.5 W/m-K, respectively. These results, along with x-ray analysis, indicated a significant development of preferred crystalline order (parallel to fibers) upon graphitization at 2400°C. The composites reinforced with ribbon fibers exhibited 3-D anisotropy, with a thermal conductivity (transverse to the fibers) of 213.5 W/m-K, higher than that parallel to the fibers (145 W/m-K). These results indicated that fiber shape can affect matrix properties in

carbon/carbon composites.

A finite element model was developed to predict the thermal conductivity of carbon/carbon composites, both parallel and transverse to the fibers. This model accounts not only for the anisotropic nature of the fibers and matrix, but also for random porosity and different types of fiber/matrix bonding (Figure 1). The model was able to accurately predict the average thermal conductivity of the composites produced in this study. Figure 2 shows graphically the agreement between predicted and measured thermal conductivity for one set of composites. Other composites showed similar agreement. The model successfully predicted the thermal conductivity parallel to the fiber axis for P55 and ribbon fiber composites. The model also predicted the thermal conductivity perpendicular to the fibers for P55 pitch-based fiber composites, but significantly underestimated the conductivity of ribbon fiber composites.

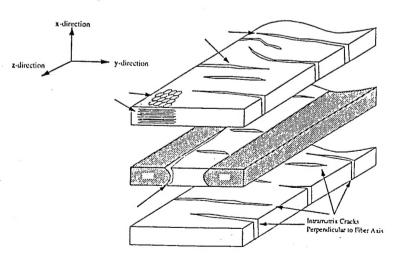


Figure 1. Exaggerated illustration of intramatrix cracking and fiber matrix debonding both parallel and perpendicular to the fiber axis in a ribbon fiber composite.

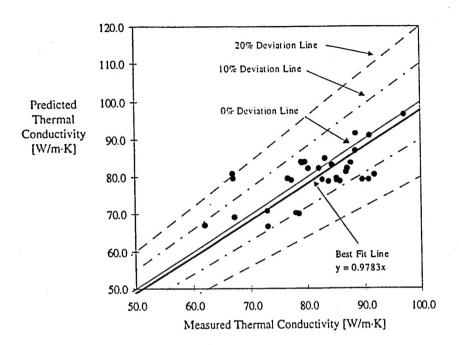


Figure 2. Plot of predicted versus measured thermal conductivity, parallel to the fibers, of individual T300/AR-120 composites heat treated to 2400°C.

#### C. Future Research

- 1. Ribbon fiber and heat-treated mesophase pitch should be used to produce high thermal conductivity carbon/carbon composites.
- 2. The towpreg fabrication method can be used to widen the processing window to include alternative pitches, which may form better composites in less time.
- 3. The finite element model produced for this study can be used to study the effect of specific material characteristics, such as fiber texture and fiber/matrix bonding, on the composite thermal conductivity.

# D. <u>List of Publications/Reports/Presentations</u>

1. Papers Published in Refereed Journals

"Flexible Towpreg for the Fabrication of High Thermal Conductivity Composites," J. W. Klett and D. D. Edie, Carbon, in press.

2. Non-Refereed Publications and Published Technical Reports "Modeling the Effects of Porosity and Fiber Structure on the Thermal Conductivit of Carbon/Carbon Composites Using the Finite Element Method," J. W. Klett, D. D. Edie, and V. J. Ervin, <u>Carbon '94</u>, Proceedings of the 6th International Conference on Carbon, Granada, Spain, July 3-8, 1994, pp. 688-689.

"Flexible Towpreg for Carbon/Carbon Composites," J. W. Klett and D. D. Edie, Proceedings of the 21st Biennial Conference on Carbon, Buffalo, NY, June 13-18, 1993, pp. 48-49.

#### 3. Presentations

a. Invited

"High Thermal Conductivity Carbon/Carbon Composites," American Carbon Society Workshop.

- b. Contributed(See item 2 above.)
- 4. Books (and sections thereof)

### LIST OF HONORS/AWARDS

Name of Person Receiving Award Recipient's Institution

Name, Sponsor and Purpose of Award

Dan D. Edie

Clemson University

Elected to the Executive Council of the American

Carbon Society

#### F. Participants

James W. Klett, completed Ph.D. in Chemical Engineering and graduated from Clemson in December, 1994.

Richard M. Dayrit, minority student currently enrolled as an M. S. student in Chemical Engineering.

Both of the above are U. S. citizens

#### G. Other Sponsored Research During FY 95

#### This Grant

"High Thermal Conductivity Carbon/Carbon Composites," Office of Naval Research, \$95,100, 0% of time, (1992-1995) \$95,100

#### Other Grants

"High Thermal Conductivity Fibers," Sponsored by the Great Lakes Composite Consortium, \$220,000/yr, 30% of time, 1/1/92 to 12/31/95.

"High Thermal Conductivity Fibers from PBO," Sponsored by ONR, 0% of time, \$31,000/yr, 7/31/94 to 8/1/97.

"Production of Carbon Monofilament- Phase II," Sponsored by MSNW, \$150,000/yr, 5% of time, 3/3/95 to 5/3/96.

"Supercritical Extraction for High Thermal Conductivity Fibers," Sponsored by DEPSCOR, \$100,000/yr, 15% of time, 9/1/94 to 8/31/97.

"Engineering Fibers and the Micromechanics of Their Composites," Sponsored by NSF, \$95,000/yr, 17% of time, 7/1/91 to 6/31/94.

# H. SUMMARY OF FY95 PUBLICATIONS/PATENTS/PRESENTATIONS/HONORS/PARTICIPANTS (Number Only)

	•			<u>ONR</u>	non ONR	
a.	Number of Papers but not yet publ		eferred Journal		_1	
b.	Number of Papers Journals:	s Published in Re	efereed			
c.	Number of Books yet Published:	or Chapters Sub	mitted but not		· · · · · · · · · · · · · · · · · · ·	
d.	Number of Books	or Chapters Pub	lished:		•	
e.	Number of Printe Non-Referred Par		orts &		2	
f.	Number of Patent	s Filed:				
g.	Number of Patent	s Granted:			•	
h.	Number of Invite or Prof. Societ		at Workshops		_1	
i.	Number of Contri Workshops or Pr	ibuted Presentat: cof. Society Mee			2	
j.	Honors/Awards/Prizes for Contract/Grant1					
k.	Number of Graduate Students and Post-Docs2 Supported at least 25% this year on contract grant:					
		Grad Students:	TOTAL Female		2	
		Post Doc:	Minority TOTAL Female Minority		1	
			FILLIOTICA	-		

Enclosure (4)

l.	Number	of	Female	or	Minority PIs or CO-PIs			•
			•	. •	New Female	_		
	•				Continuing Female	-	<del></del>	
					New Minority Continuing Minority	-		

Enclosure (4) contd.